

inside[™] XEON[®]

Intel® Ethernet Server Adapter 1350

Dual- and Quad-port Gigabit Ethernet server adapters designed with performance enhancing features and new power management technologies

Key Features

- Halogen-free dual- or quad-port Gigabit Ethernet adapters with copper or fiber interface options
- Innovative power management features including Energy Efficient Ethernet (EEE) and DMA Coalescing for increased efficiency and reduced power consumption
- Flexible I/O virtualization for port partitioning and quality of service (QoS) of up to 32 virtual ports
- Scalable iSCSI performance delivering cost-effective SAN connectivity
- High-performing bridgeless design supporting PCI Express* Gen 2.1 5GT/s
- Reliable and proven Gigabit Ethernet technology from Intel Corporation

Overview

The new Intel® Ethernet Server Adapter I350 family builds on Intel's history of excellence in Ethernet products. Intel continues its market leadership with this new generation of PCIe* GbE network adapters. Built with the bridgeless Intel® Ethernet Controller I350, these adapters represent the next step in the Gigabit Ethernet (GbE) networking evolution for the enterprise and data center by introducing new levels of performance through industry-leading enhancements for both virtualized and iSCSI Unified Networking environments. This new family of adapters also includes new power management technologies such as Energy Efficient Ethernet (EEE) and DMA Coalescing (DMAC).

Flexible I/O Virtualization

The Intel[®] Ethernet Server Adapter I350 family includes Intel[®] Virtualization Technology for connectivity (Intel[®] VT-c) to deliver I/O virtualization and Quality of Service (QoS) features designed directly into the controller on the adapter. I/O virtualization advances network connectivity models used in today's servers to more efficient models by providing Flexible Port Partitioning (FPP), multiple Rx/Tx queues, and on-controller QoS functionality that can be used in both virtual and non-virtual server deployments.

By taking advantage of the PCI-SIG SR-IOV specification, Intel® Ethernet products enable Flexible Port Partitioning (FPP). With FPP, virtual controllers can be used by the Linux* host directly and/or assigned to virtual machines. With this port partitioning, administrators can create up to eight dedicated connections on a single Ethernet port for use in bare-metal and virtualized server deployments.

In a bare-metal Linux server, host processes can be assigned to dedicated network resources to provide traffic isolation and balanced bandwidth allocation.

In a virtualized environment, a VM can be assigned to a virtual controller to reduce the CPU overhead seen when using a software-based network bridge by offloading network traffic management to the controller.

Scalable iSCSI Performance

An Intel Ethernet Server Adapter I350 with native iSCSI initiators built into Microsoft* Windows*, Linux*, and VMware* ESX platforms provides a simple, dependable, cost-effective way to connect to iSCSI SANs. These native initiators are broadly tested using multiple generations of operating systems, storage systems, and OS tools to help ensure reliability and ease of use. Standardizing on Intel® Ethernet Adapters for iSCSI enables administrators to use a single initiator, TCP/IP stack, and a common set of management tools and IT policies. In addition, Intel[®] Ethernet Server Adapters include a number of hardware features designed to accelerate iSCSI traffic and enhance data processing. For example, TCP segmentation offload and checksum offload capabilities help reduce processor usage, increase throughput, and deliver exceptional iSCSI performance. Finally, using native OS initiators, an Intel Ethernet Server Adapter I350 supports the CRC-32 digest instruction set included with Intel® Xeon® processor products, which improves transmission reliability and delivers an enterpriseclass iSCSI solution.

Power Management Technologies

Today, companies everywhere are looking for ways to decrease energy consumption across the enterprise to reduce costs and environmental impact, while at the same time solving increasingly important power density challenges. That's why Intel has introduced new, advanced Power Management Technologies (PMTs) with the Intel Ethernet Server Adapter I350 family that enable enterprises to configure power options on the adapter and more effectively manage their power consumption.

Energy Efficient Ethernet (EEE)

The Intel Ethernet Server Adapter I350 family supports the IEEE802.3az Energy Efficient Ethernet (EEE) standard so that, during periods of low network activity, EEE reduces the power

consumption of an Ethernet connection by negotiating with a compliant EEE switch port to transition to a low power idle (LPI) state. This reduces the controller power to approximately 50% of its normal operating power, saving power on the network port and the switch port. As soon as increased network traffic is detected, the controller and the switch quickly come back to full power to handle the increased network traffic. EEE is supported for both 1000BASE-T and 100BASE-TX.

DMA Coalescing

Another power management technology that can reduce power on the server platform is DMA Coalescing (DMAC). Typically, when a packet arrives at a server, DMA calls are made to transfer the packet within the server. These calls wake up the processor, memory and other system components from a lower power state in order to perform the tasks required to handle the incoming packet.

Based on the configurable DMAC settings, incoming packets are buffered momentarily before any DMA calls are made. This enables the controller to intelligently identify opportunities to batch multiple packets together so that when components are wakened from lower power states they can efficiently handle the batched packets at the same time. This enables platform components to remain in lower power states longer, which can dramatically reduce platform energy consumption. DMAC synchronizes DMA calls across all controller ports to ensure maximum power savings.

Software Tools and Management

Intel® Advanced Network Services (Intel® ANS) include new teaming technologies and techniques such as Virtual Machine Load-Balancing (VMLB) for Hyper-V environments. Today, Intel ANS includes a variety of teaming configurations for up to eight adapters, support for mixed vendors server adapters teaming and includes support for 802.1q VLANs, making Intel ANS one of the most capable and comprehensive tools for supporting server adapter teaming.

Additionally, Intel[®] PROSet for Windows* Device Manager and PROset CL extends driver functionality to provide additional reliability and Quality of Service features and configuration.



Source: Intel Labs Energy Efficient Ethernet reduces the controller power to approximately 50% of its normal operating level.



less time between DMA calls to reach and stay in lower power states.

With more time between DMA calls, components can reach lower power states and remain in them longer.

General Features	
Features	Benefits
Intel® Ethernet Controller I350 with PCI Express* V2.1 (5 GT/s) Support	 Industry-leading smallest non-bridged PCIe Gen2 quad-port 1 GbE controller Enables customers to take full advantage of 1 GbE by providing maximum bi-directional throughput per port on a single quad-port adapter
Halogen Free¹ (Copper)	Leadership in an environmentally friendly ecosystem
Low-Profile (Dual and Quad Port Copper; Dual-Port Fiber) and Standard height (Quad-Port Fiber)	• Enables higher bandwidth and throughput from standard and low-profile PCIe slots and servers
Ethernet Features	
Features	Benefits
IEEE* 802.3 auto-negotiation	Automatic link configuration for speed, duplex, flow control
1Gb/s Ethernet IEEE 802.3, 802.3u, 802.3ab PHY specifications Compliant	Robust operation over installed base of Category-5 twisted-pair cabling
Integrated PHY for 10/100/1000 Mb/s for multispeed, full- and half-duplex	Smaller footprint and lower power dissipation compared to multiple discreet MAC and PHY
IEEE 802.3x and 802.3z compliant flow control support with software-controllable Rx thresholds and Tx pause frames	Local control of network congestion levels Frame loss reduced from receive overruns
Automatic cross-over detection function (MDI/MDI-X)	The PHY automatically detects which application is being used and configures itself accordingly
IEEE 1588 protocol and 802.1AS implementation	 Time-stamping and synchronization of time sensitive applications Distribute common time to media devices
Power Management and Efficiency	
Features	Benefits
<1W S0-Max (state) 1000BASE-T Active 90oC (mode) <400mW S0-Typ (state) 100BASE-T Active (mode)	Controller is designed for low power consumption
IEEE802.3az - Energy Efficient Ethernet (EEE)	Power consumption of the PHY is reduced by approximately 50% link transitions to low power Idle (LPI) state as defined in the IEEE802.3az (EEE) standard
DMA Coalescing	 Reduces platform power consumption by coalescing, aligning, and synchronizing DMA Enables synchronizing port activity and power management of memory, CPU and RC internal circuitry
Smart Power Down (SPD) at S0 no link / Sx no link	PHY powers down circuits and clocks that are not required for detection of link activity
Active State Power Management (ASPM) Support	Optionality Compliance bit to help determine whether to enable ASPM or whether to run ASPM compliance tests to support entry to LOs
LAN disable function	Option to disable the LAN Port and/or PCIe Function. Disabling just the PCIe function but keeping the LAN port that resides on it fully active (for manageability purposes and BMC pass-through traffic).
Full wake up support • Advanced Power Management (APM) Support (formerly Wake on LAN) • Advanced Configuration and Power Interface (ACPI) specification v2.0c • Magic Packet* wake-up enable with unique MAC address	 APM—Designed to receive a broadcast or unicast packet with an explicit data pattern (Magic Pack) and assert a signal to wake up the system ACPI—PCIe power management based wake-up that can generate system wake-up events from a number of sources
ACPI register set and power down functionality supporting D0 and D3 states	• A power-managed link speed control lowers link speed (and power) when highest link performance is not required
MAC Power Management controls	Power management controls in the MAC the PHY can be entered into a low-power state
Low Power Link Up—Link Speed Control	• Enables a link to come up at the lowest possible speed in cases where power is more important than performance
Power Management Protocol Offload (Proxying)	• Avoid spurious wake up events and reduce system power consumption when the device is in D3 low power state and system is in S3 or S4 low power states
Latency Tolerance Reporting (LTR)	 Reports service latency requirements for memory reads and writes to the Root Complex for system power management
I/O Virtualization Features	
Features	Benefits
Eight transmit (Tx) and receive (Rx) queue pairs per port	Supports VMware* NetQueue and Microsoft* VMQ
Flexible Port Partitioning: 32 Virtual Functions on Quad-port or 16 Virtual Functions on Dual-port	 Virtual Functions (VFs) appear as Ethernet Controllers in Linux OSes that can be assigned to VMs, Kernel processes or teamed using the Linux* Bonding Drivers
Support for PCI-SIG SR-IOV specification	• Up to 8 Virtual Functions per Port
Rx/Tx Round-Robin Scheduling	Assigns time slices in equal portions in circular order for Rx/Tx for balanced bandwidth allocation
Traffic Isolation	Processes or VMs can be assigned a dedicated VF with VLAN support
Traffic Steering	Offloads sorting and classifying traffic in to VF or queues
VM to VM Packet forwarding (Packet Loopback)	On-chip VM-VM traffic enables PCIe* speed switching between VM
MAC and VLAN anti-spoofing	Enables anti spoofing filter on MAC addresses and VLAN for VFs.
Malicious driver detection	Monitors queues and VFs for malformed descriptors that might indicate a malicious or buggy driver.

I/O Virtualization Features continued	
Features	Benefits
Storm control	Limits to the broadcast or multicast traffic it can receive
Per-pool statistics, offloads, and jumbo frames support	Each Queue Pair or Pool has its own statistics, off-loads and Jumbo support options
Independent Function Level Reset (FLR) for Physical and Virtual Functions	• VF resets only the part of the logic dedicated to specific VF and does not influence the shared port
IEEE 802.1q Virtual Local Area Network (VLAN) support with VLAN tag insertion, stripping and packet filtering for up to 4096 VLAN tags	 Adding (for transmits) and removing (for receives) of VLAN tags with no VM involvement Filtering packets belonging to certain VLANs
IEEE 802.1q advanced packet filtering	Lower processor utilization
Mirroring rules	Ability to reflect network traffic to a given VM or VLAN based on up to four rules
Support for Simple VEPA	Support for external VM switching
VF Promiscuous modes	• VLAN, unicast, multicast
Stateless Offloads/Performance Feature	s
Features	Benefits
TCP/UDP, IPv4 checksum offloads (Rx/ Tx/Large-send); Extended Tx descriptors for more offload capabilities	 Improved CPU usage Checksum and segmentation capability extended to new standard packet type
IPv6 support for IP/TCP and IP/UDP receive checksum offload	Improved CPU usage
Tx TCP segmentation offload (IPv4, IPv6)	 Increased throughput and lower processor usage Compatible with large-send offload
Transmit Segmentation Offloading (TSO)	Large TCP/UDP I/O is segmented by to the device it to L2 packets according to the requested MSS
Interrupt throttling control	Limits maximum interrupt rate and improves CPU utilization
Legacy and Message Signal Interrupt (MSI) Modes	Interrupt mapping
Message Signal Interrupt Extension (MSI-X)	Dynamic allocation of up to 25 vectors per port
Intelligent interrupt generation	Enhanced software device driver performance
Receive Side Scaling (RSS) for Windows environment Scalable I/O for Linux environments (IPv4, IPv6, TCP/UDP	• Up to eight queues per port
Support for packets up to 9.5K Bytes (Jumbo Frames)	 Improves the system performance related to handling of network data on multiprocessor systems Enables higher and better throughput of data
Low Latency Interrupts	 Based on the sensitivity of the incoming data, the controller can bypass the automatic moderation of time intervals between the interrupts
Header/packet data split in receive	Helps the driver to focus on the relevant part of the packet without the need to parse it
PCIe v2.1 TLP Processing Hint Requester	Provides hints on a per transaction basis
Descriptor ring management hardware for Transmit and Receive	Optimized descriptor fetch and write-back for efficient system memory and PCIe bandwidth usage
Remote Boot Options	
Features	Benefits
Preboot eXecution Environment (PXE) flash interface support	Enables system boot up via the EFI (32 bit and 64 bit) Flash interface for PXE 2.1 option ROM
Intel [®] Ethernet iSCSI Remote Boot for Windows, Linux, and VMware	Enables system boot up via iSCSI Provides additional network management capability
Intel Boot Agent software: Linux boot via PXE or BOOTP, Windows* Deployment Services, or UEFI	 Enables networked computer to boot using a program code image supplied by a remote server Complies with the Pre-boot eXecution Environment (PXE) Version 2.1 Specification
Manageability Features	
Features	Benefits
Management Component Transport Protocol (MCTP)	Baseboard management controller (BMC) communication between add-in devices using a standardized protocol
Firmware Based Thermal Management	• Can be programmed via the BMC to initiate thermal actions and report thermal occurrences
IEEE 802.3 MII Management Interface	Enables the MAC and software to monitor and control the state of the PHY
MAC/PHY Control and Status	• Enhanced control capabilities through PHY reset, link status, duplex indication, and MAC Dx power state
Watchdog timer	Defined by the FLASHT register to minimize Flash updates
Extended error reporting	Messaging support to communicate multiple types/severity of errors
Controller Memory Protection	Main internal memories are protected by error correcting code (ECC) or parity bits

Page and galay specification susport - Standard Intell '00 Acceleration Technology Intell' (007) - Easerner system throughout, Standard Operating Status (000000000000000000000000000000000000	Adapter Product Features	
Inter 10 Academia Technology (Intel® (IXAT) - Extreme system introlog(put. Ships eth (Un-hog)(transmitted) (weynorite bracket Ships eth (Un-hog)(transmitted) (weynorite bracket Ships eth (Un-hog)(transmitted) Intel acking Inter action in the academia of the action in the actio		- Standard
Balas of Mul-Progression(PC), Yes and Ps), Weekson Ps), Steamines installation Califie distance - Coppenting to 1: 100 m Intel Backing - General - General - Comments - Califie distance - Specifications - Califie distance - Specifications - Califier distance - Specifications - Califier distance - Specifications - Califier distance -		
Cable distance - Copper: (up to 100 m + Filter: up to 100 m + Filter: up to 100 m + Filter: up to 300 m + Filter: Up to 200 m + Filter: Filter: Filter: Filter: Filter: Filter: Filter: Filter: Filt	Ships with full-height bracket installed; low-profile bracket	
Intel Backing Linited Lifetime Warrany Specifications General Consectors • 12-45 (Copper) Lifetime Variany • EEE 802.3/108.45E T, 1008.45E T, 10008.45E T Calaling • Cupper: Catagory - 5 on Signation Catagory - 5	included in package (T2, T4 and F2) Cable distance	
Luinted Lifetime Warranty 90-Usy, more-back guarantee (U.S. und Canada) Specifications Concertal Connectors Protectors Pr	Justal Dealting	• Fiber: up to 300 m
90 day, money hack garavanete (US, and Canada) Specifications General Connectors • E21-45 (Cooper) • E2 Family of part of part of part of the part o		
Specifications General Connectors • RU-4S (Copper) • ICE Form Optic (Falser) IEEE transdardmetwork topology • IEEE 802.3/108A5E-17, 1000BASE-T Catling: • Coppert Coppert on Inspect for 108A5E-17, poweration Category-So fright for 1080BASE-T operation • Category-So fright for 1080BASE-T operation • Category-So fright for 1080BASE-T operation • Category-So fright for 1080BASE-T operation • Technical Data rets supported per port: • 10/100/1000 Mtps (Copper), 1000 Mtps (Falser) Bas width • 10/100/1000 Mtps (Copper), 1000 Mtps (Falser) Bas width • 4-Jane PCI Express: operable in x4, x8 and x16 slots Interrupt levels • INTA, INTE, INTC, INTO, MSI, MSI, X Hardware certifications • FCC B, U, C.Y. VCL, BSM, CTCK, KCC Controller-processor • Interrupt levels • Organ • 4.4 AV 135574 A.6 AV * Storg S, S.W * Storg S, S.W Storget temperature • 0.4 C to 55° (12° F to 13° F) Storget temperature • 0.4 C to 55° (12° F to 13° F) Storget temperature • 0.4 C to 55° (12° F to 13° F) Storget temperature • 0.4 C to 55° (12° F to 13° F) Storget temperature • 0.4 C to 55° (12° F to 13° F) Storget temberature		
General Connectors •RJ 46 (Copper) LCF Der Oppic (Filee) IEEE standardinetwork topology •IEEE 802.3/108ASE-T, 1008ASE-T, 1008ASE-T Cabing: •Copper: Cargory 5 of higher for 108ASE = provation Cargory 5 of higher for 108ASE = reperation Cargory 5 of higher for 108ASE = reperation Cargory 5 of higher for 108ASE = reperation Cargory 5 of higher for 108ASE = reperation Technical D Data rate supported per part: •10/100/1000 Mbps (Copper), 1000 Mbps (Fiber) Bus type •PCIE Spress 21 (6 GT/s) Bus width •4. Lare PCI Express 21 (6 GT/s) Bus width •4. Lare PCI Express 21 (6 GT/s) Bus width •4. Lare PCI Express 21 (6 GT/s) Bus width •4. Lare PCI Express 21 (6 GT/s) Bus width •4. Lare PCI Express 21 (6 GT/s) Bus width •4. Lare PCI Express 21 (6 GT/s) Bus width •4. Lare PCI Express 21 (6 GT/s) Bus width •4. Lare PCI Express 21 (6 GT/s) Bus width •4. Lare PCI Express 21 (6 GT/s) Bus width •4. Lare PCI Express 20 (Corgorer) Interrupt levels •INTA_INTS_INTC_INTD_NSI_MSLX Bus des models and x is 8 of x		
Connectors • RJ-45 (Copper) • LC PReV Optic (Files) EEE Baardund/metwork topology • EEE Boardund/Reader, 100BASE, TX, 100BASE, TX Cabling: • Copper) • Copper) • Copper) • Copper) • Copper) • Price: • Riber: • R		
IEE Bandard/network.topology IEEB 02 3/108 ASE T, 1008 ASE T IEEE Standard/network.topology IEEB 02 3/108 ASE T, 1008 ASE T, operation Category-5 or higher for 1008 ASE T operation Category-5 or higher for 1008 ASE T operation Category-6 or higher for 1008 ASE T operation Category-6 or higher for 1008 ASE T operation Technical Image 12 and 1000 Mbps (Copper), 1000 Mbps (Fiber) Bas type PCIE Styness 2.21 (5 G7)(9) Bus with -4 lone PCI Express 2.21 (5 G7)(9) Bus with -4 lone PCI Express 2.21 (5 G7)(9) Bus with -4 lone PCI Express 2.21 (5 G7)(9) Bus with -4 lone PCI Express 2.21 (5 G7)(9) Bus with -4 lone PCI Express 2.21 (5 G7)(9) Bus with -4 lone PCI Express 2.21 (5 G7)(9) Bus with -4 lone PCI Express 2.02 (CL BSM), CL RSM, CL RSM COME Controller processor -Intel Ethernet Controller 150 Power consumption (typical) "BST22 2.4 aw 18507242 2.4 aw 18507242 2.6 bw Storage tummidty -90% hon-condensing relative humidity at 35 °C Connect Spaced ED Indicators -100 (T S 15 S °C (22 °F to 131 °F) Storage humidity +90% hon-condensing relative humidity at 35 °C Connect Spaced ED Indicators -100 (Mbys green=100 Mbys green=10 Mbys		
Cobing: Copper: Category 5 or higher for 100.85.81 T operation Category 5 or higher for 100.85.81 T operation Category 5 or higher for 100.85.81 T operation Fiber: Mere 25,50 um Technical Data rate supported per port: • 10/100/1000 Mbps (Copper), 1000 Mbps (Fiber) Bus sype • PCI Express 2.1 (5 GT/s) Bus width • 4-lane PCI Express, porable in x4, x8 and x16 slors Interrupt levels • INTA, INTE, INTC, INTO, MSI, MSI X Hardware certifications • FCC B, UL, CE, VCCI, BSML, CTICK, KCC Controller-processor • Intel Etheric Controller 1350 Power consumption (typical) • Copper: 135074 6.0 W Operating temperature • 0.4 Co 55 % (2.2 °F to 131 °F) Storage temperature • 0.9 °C to 55 °C (2.2 °F to 131 °F) Storage temperature • 0.9 °C to 55 °C (2.2 °F to 131 °F) Storage temperature • 0.9 °C to 55 °C (2.2 °F to 131 °F) Storage temperature • 0.9 °C to 55 °C (2.2 °F to 131 °F) Storage temperature • 0.9 °C to 55 °C (2.2 °F to 131 °F) Storage temperature • 0.9 °C to 55 °C (2.2 °F to 131 °F) Storage temperature • 0.9 °C to 55 °C (2.2 °F to 131 °F) Connect Speed LED Indicators • Not Illuminated -10 MKJs; geneer-1605 (Copper) • Torer 160/S. NotIlluminated		
Calegory-3 or higher for 108ASE-T operation Category-5e or higher for 108ASE-T operation Technical Data rate supported per port: •10/100/1000 Mbps (Copper), 1000 Mbps (Fiber) Bus width •4 lane PCI Express? 2.1 (5 GT/s) Bus width •4 lane PCI Express? perable in x4, x8 and x16 slots Interrupt levels •INTA. NTB, INTC, INTO, MSI, MSI-X Hardware certifications •FCC B, UL, CE, VCCI SMU, CTCK, KCC Controller- processor •Intel Ethernet Controller 1330 Pawer consumption (typical) Copper: ISSOT2V2 4.4 W ISSOT4V2 5.0 W · Fiber: ISSOT2V 5.0 W ·	IEEE standard/network topology	• IEEE 802.3/10BASE-T, 100BASE-TX, 1000BASE-T
Dar atte supported per port: 10/100/1000 Mbps (Copper), 1000 Mbps (Fiber) Bus type • PCI Express* 2.1 (5 GT/s) Bus width • 4-lane PCI Express; operable in x4, x8 and x16 slots Interrupt levels • INTA, INTB, INTC, INTD, MSI, MSI-X Hardware certifications • FCC B, UL, CE, VCCI, BSMI, CTICK, KCC Controller- processor • Intel Ethernet Controller 1350 Power consumption (typical) • 050727, 2, 4, W 1350742, 2, 5, W 1350742, 6, 0W • Power consumption (typical) • 0°C to 55 °C (32 °F to 131 °F) Storage temperature • 0 °C to 55 °C (32 °F to 131 °F) Storage temperature • 0°C to 55 °C (32 °F to 131 °F) Storage temperature • 0°C to 55 °C (32 °F to 131 °F) Storage temperature • 0°C to 55 °C (32 °F to 131 °F) Storage temperature • 0°C to 55 °C (32 °F to 158 °F) Storage temperature • 0°C to 55 °C (32 °F to 158 °F) Storage temperature • 0°C to 55 °C (32 °F to 158 °F) Storage temperature • 0°C to 70° °C (40 °F to 158 °F) Storage temperature • 0°C to 70° °C (40 °F to 158 °F) Storage temperature • 0°C to 70° °C (40 °F to 158 °C) Connect Speed LED Indicators • Not Illuminated = no link (Fiber)	Cabling:	Category-3 or higher for 10BASE-T operation Category-5 or higher for 100BASE-TX operation Category-5e or higher for 1000BASE-T operation • Fiber:
Bus type • PCI Express* 2.1 (5 GT/s) Bus width -4-lane PCI Express; operable in x4, x8 and x16 slots Interrupt levels • INTA, INTB, INTC, INTD, MSI, MSI-X Hardware certifications • FCC B, UL, CE, VCCI, BSMI, CTICK, KCC Controller-processor • Intel Ethernet Controller 1350 Power consumption (typical) Copper: 135072V 2.4 4W 135072V 2.4 4W 135072V 2.4 4W 135072V 2.4 0W * Fiber: 135072 2.5 0W Power consumption (typical) Copper: 135072 2.5 0W * Fiber: 135072 5.5 W 135072V 2.4 0W * Fiber: 135072 5.5 W Storage temperature • O*C to 55*C (32*F to 131*F) Storage temperature • -40*C to 70*C (+40*F to 158*F) Storage temperature • -40*C to 70*C (+40*F to 158*F) Storage tumidity • 90% non-condensing relative humidity at 35*C Connect Speed LED Indicators • Not Illuminated=10 Mb/s; green=10 Mb/s; Gopper) • Green=1 Gb/s. Not Illuminated=10 Mb/s; green=10 Mb/s; Gopper) • Green=1 Gb/s. Not Illuminated=10 Mb/s; green=10 M	 Technical	
Bis width -4-lane PCI Express; operable in x4, x8 and x16 slots Interrupt levels -INTA, INTB, INTC, INTO, MSI, MSI-X Hardware certifications -FCC B, UL, CE, VCCI, BSMI, CTICK, KCC Controller-processor -Intel Ethernet Controller 1350 Power consumption (typical) -Copper: 185072V2 4.4W 183074V2 5.0W Power consumption (typical) -Copper: 185072 5.5 W 183074V 5.0W Storage temperature -0°C to 55°C (32°F to 131°F) Storage temperature -0°C to 55°C (32°F to 158°F) Storage temperature -0°C to 55°C (32°F to 158°F) Storage temperature -0°C to 70°C (-40°F to 158°F) Storage temperature -0°C to 55°C (32°F to 158°F) Storage temperature -0°C to 55°C (32°F to 158°F) Storage temperature -0°C to 70°C (-40°F to 158°F) Storage temperature -0°C to 70°C (-40°F to 158°F) Storage temperature -10°C to 70°C (-40°F to 158°F)	Data rate supported per port:	• 10/100/1000 Mbps (Copper), 1000 Mbps (Fiber)
Interrupt levels •INTA, INTB, INTC, INTD, MSI, MSI-X Hardware certifications •FCC B, UL, CE, VCCI, BSMI, CTICK, KCC Controller-processor •Intel Ethernet Controller 1350 Power consumption (typical) •Copper: 13507242 4.4W 13507422 Operating temperature •Or Ct to 55 °C (32 °F to 131 °F) Storage temperature •Or Ct to 55 °C (32 °F to 131 °F) Storage temperature •Or Ct to 55 °C (32 °F to 131 °F) Storage temperature •Or Ct to 55 °C (32 °F to 131 °F) Storage temperature •Or Ct to 55 °C (32 °F to 131 °F) Storage temperature •Or Ct to 55 °C (32 °F to 131 °F) Storage temperature •Or Ct to 55 °C (32 °F to 131 °F) Storage temperature •Or Ct to 55 °C (32 °F to 131 °F) Storage temperature •Or Ct of 0°C (40 °F to 158 °F) Storage temperature •Or Ct of 0°C (40 °F to 158 °F) Storage temperature •Or Ct (40 °F to 158 °F) Storage temperature •Or Ct (40 °F to 158 °F) Storage temperature •Or Ct (40 °F to 158 °F) Storage temperature •Or Ct (40 °F to 158 °F) Storage temperature •Or Ct (40 °F to 158 °F) Physical Dimensions •Storage temperature <t< td=""><td>Bus type</td><td>PCI Express* 2.1 (5 GT/s)</td></t<>	Bus type	PCI Express* 2.1 (5 GT/s)
Hardware certifications • FCC B, UL, CE, VCCI, BSMI, CTICK, KCC Controller-processor • Intel Ethernet Controller 1350 Power consumption (typical) Lopper: 1350742 2.4.W 1350742 3.6.0 W • Fibar: 135074 5.6.0 W Operating temperature • 0°C to 55 °C (32 °F to 131 °F) Storage temperature • 0°C to 55 °C (32 °F to 131 °F) • 0°C to 70 °C (-40 °F to 158 °F) Storage temperature • -40 °C to 70 °C (-40 °F to 158 °F) • 0°C to 70 °C (-40 °F to 158 °F) Storage tumidity • 90% non-condensing relative humidity at 35 °C • 0°C to 70 °C (-40 °F to 158 °F) Connect Speed LED Indicators • Not illuminated=10 Mb/s; green=100 Mb/s; amber=1 Gb/s (Copper) • Green=1 Gb/s. Not illuminated=no link (Fiber) Physical Dimensions • 0°C to 70 °C (-40 °F to 153 °F) Copper T2 & T4; Fiber F2 • Not illuminated=no link (Fiber) Length • 13.54 cm (5.33 in.) Width • 6.89 cm (2.71 in.) Full-height end bracket • 12.0 cm (4.725 in.) Low-profile end bracket • 7.92 cm (3.117 in.) Fiber F4 • 13.54 cm (5.33 in.) Length • 13.54 cm (5.33 in.) Width • 13.54 cm (5.33 in.) Width • 13.54 cm (5.33 in.) Width <td>Bus width</td> <td>4-lane PCI Express; operable in x4, x8 and x16 slots</td>	Bus width	4-lane PCI Express; operable in x4, x8 and x16 slots
Controller-processor Intel Ethernet Controller 1350 Power consumption (typical) ^C opper: 1350742 4.4 W 1350742 5.5 W 1350742 5.0 W •Fiber: 1350742 5.0 W •Fiber: 135074 6.0 W Operating temperature •0 °C to 55 °C (32 °F to 131 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °F) Storage temperature •-40 °C to 70 °C (-40 °F to 158 °C) Copper 12 & 14; Fiber F2 Intel temperature Length •13.54 cm (5.33 in.) Width •13.54 cm (- Interrupt levels	• INTA, INTB, INTC, INTD, MSI, MSI-X
Power consumption (typical) Copper: I350T422 4.4 W I350T422 5.0 W Fiber: I35074 6.0 W Operating temperature 0 °C to 55 °C (32 °F to 131 °F) Storage temperature 0 °C to 55 °C (32 °F to 131 °F) Storage temperature 0 °C to 70 °C (-40 °F to 158 °F) Storage temperature 0 °C to 70 °C (-40 °F to 158 °F) Storage temperature 0 °C to 70 °C (-40 °F to 158 °F) Storage temperature 0 °C to 70 °C (-40 °F to 158 °F) Storage temperature 0 °C to 70 °C (-40 °F to 158 °F) Storage temperature 0 °C to 70 °C (-40 °F to 158 °F) Storage temperature 0 °C to 70 °C (-40 °F to 158 °F) Storage temperature 9 °C to 70 °C (-40 °F to 158 °F) Storage temperature 9 °C to 70 °C (-40 °F to 158 °F) Connect Speed LED Indicators Not Illuminated=no link (Fibe		• FCC B, UL, CE, VCCI, BSMI, CTICK, KCC
IBSOTZV2 4.4 W IBSOTZV2 5.0 W Storage temperature · 40 °C to 70 °C (-40 °F to 158 °F) Storage temperature · 40 °C to 70 °C (-40 °F to 158 °F) Storage temperature · 40 °C to 70 °C (-40 °F to 158 °F) Storage temperature · 40 °C to 70 °C (-40 °F to 158 °F) Storage temperature · 40 °C to 70 °C (-40 °F to 158 °F) Storage temperature · 90% non-condensing relative humidity at 35 °C Connect Speed LED Indicators · Not illuminated=10 Mb/s: green=100 Mb/s: green=10b/s (Copper) · Green=1 Gb/s. Not illuminated=no link (Fiber) Physical Dimensions Length · 13.54 cm (5.33 in.) Wi	Controller-processor	Intel Ethernet Controller I350
Operating temperature.0 °C to 55 °C (32 °F to 131 °F)Storage temperature40 °C to 70 °C (-40 °F to 158 °F)Storage humidity.90% non-condensing relative humidity at 35 °CConnect Speed LED Indicators. Not illuminated=10 Mb/s; green=100 Mb/s; amber=1 Gb/s (Copper) . Green=1 Gb/s. Not illuminated=no link (Fiber)Physical Dimensions	Power consumption (typical)	I350T2V2 4.4 W I350T4V2 5.0 W • Fiber: I350F2 5.5 W
Storage temperature 40 °C to 70 °C (-40 °F to 158 °F) Storage humidity -90% non-condensing relative humidity at 35 °C Connect Speed LED Indicators -Not illuminated=10 Mb/s; green=100 Mb/s; amber=1 Gb/s (Copper) • Green=1 Gb/s. Not illuminated=no link (Fiber) Physical Dimensions Copper T2 & T4; Fiber F2		
Storage humidity •90% non-condensing relative humidity at 35 °C Connect Speed LED Indicators •Not illuminated=10 Mb/s; green=100 Mb/s; amber=1 Gb/s (Copper) • Green=1 Gb/s. Not illuminated=no link (Fiber) Physical Dimensions Copper T2 & T4; Fiber F2 Length •13.54 cm (5.33 in.) Width •6.89 cm (2.71 in.) Full-height end bracket •12.0 cm (4.725 in.) Low-profile end bracket •7.92 cm (3.117 in.) Fiber F4 •13.54 cm (5.33 in.) Width •13.54 cm (5.33 in.) Fiber F4 •13.54 cm (5.33 in.) Length •13.54 cm (5.33 in.)		
Connect Speed LED Indicators • Not illuminated=10 Mb/s; green=1 Gb/s (Copper) • Physical Dimensions Copper T2 & T4; Fiber F2 Length • 13.54 cm (5.33 in.) Width • 6.89 cm (2.71 in.) Full-height end bracket • 12.0 cm (4.725 in.) Low-profile end bracket • 7.92 cm (3.117 in.) Fiber F4 • 13.54 cm (5.33 in.) Width • 13.54 cm (5.33 in.)		
Physical Dimensions Copper T2 & T4; Fiber F2 Length 13.54 cm (5.33 in.) Width 6.89 cm (2.71 in.) Full-height end bracket 12.0 cm (4.725 in.) Low-profile end bracket 7.92 cm (3.117 in.) Fiber F4 13.54 cm (5.33 in.) Width 11.54 cm (5.33 in.) Width 11.12 cm (4.376 in) Full-height end bracket 12.0 cm (4.725 in.)		Not illuminated=10 Mb/s; green=100 Mb/s; amber=1 Gb/s (Copper)
Copper T2 & T4; Fiber F2 Length • 13.54 cm (5.33 in.) Width • 6.89 cm (2.71 in.) Full-height end bracket • 12.0 cm (4.725 in.) Low-profile end bracket • 7.92 cm (3.117 in.) Fiber F4 • 13.54 cm (5.33 in.) Width • 13.54 cm (5.33 in.) Width • 11.12 cm (4.376 in) Full-height end bracket • 12.0 cm (4.725 in.)	Physical Dimensions	
Length • 13.54 cm (5.33 in.) Width • 6.89 cm (2.71 in.) Full-height end bracket • 12.0 cm (4.725 in.) Low-profile end bracket • 7.92 cm (3.117 in.) Fiber F4 - Length • 13.54 cm (5.33 in.) Width • 13.54 cm (5.33 in.) Width • 11.12 cm (4.376 in) Full-height end bracket • 12.0 cm (4.725 in.)		
Full-height end bracket • 12.0 cm (4.725 in.) Low-profile end bracket • 7.92 cm (3.117 in.) Fiber F4 Length • 13.54 cm (5.33 in.) Width • 11.12 cm (4.376 in) Full-height end bracket • 12.0 cm (4.725 in.)	Length	• 13.54 cm (5.33 in.)
Low-profile end bracket • 7.92 cm (3.117 in.) Fiber F4 Length • 13.54 cm (5.33 in.) Width • 11.12 cm (4.376 in) Full-height end bracket • 12.0 cm (4.725 in.)	Width	• 6.89 cm (2.71 in.)
Fiber F4 Length • 13.54 cm (5.33 in.) Width • 11.12 cm (4.376 in) Full-height end bracket • 12.0 cm (4.725 in.)	– Full-height end bracket	• 12.0 cm (4.725 in.)
Length • 13.54 cm (5.33 in.) Width • 11.12 cm (4.376 in) Full-height end bracket • 12.0 cm (4.725 in.)	Low-profile end bracket	• 7.92 cm (3.117 in.)
Width • 11.12 cm (4.376 in) - - - - - - - - - -	Fiber F4	
Full-height end bracket • 12.0 cm (4.725 in.)	 Length	• 13.54 cm (5.33 in.)
	Width	• 11.12 cm (4.376 in)
Low-profile end bracket N/A	– Full-height end bracket	• 12.0 cm (4.725 in.)
	Low-profile end bracket	N/A

Operating System/Architecture Support				
OPERATING SYSTEM	IA32	X64	IPF ¹	
Windows Server 2003 SP2	Y	Y	Ν	
Windows Server 2008 SP2	Y	Y	Ν	
Windows Server 2008 SP2 Core	Y	Y	n/a	
Windows Server 2008 SP2 (w/ Hyper-V role)	n/a	γ2	n/a	
Hyper-V Server 2008 SP2	n/a	γ2	n/a	
Windows Server 2008 R2	n/a	Y	٠N	
Windows Server 2008 R2 Core	n/a	Y	N	
Windows Server 2008 R2 (w/Hyper-V role)	n/a	γ2	n/a	
Hyper-V Server 2008 R2	n/a	γ2	n/a	
WinPE 1.6 (2003 PE)	Y	Y	n/a	
WinPE 2.1 (2008 PE)	Y	Y	n/a	
WinPE 3.0 (2008 R2 PE)	Y	Y	n/a	
Linux* Stable Kernel version 3.X, 2.6, X	Y	Y	n/a	
Linux RHEL 5.6	Y	Y	٠N	
Linux RHEL 6.1	Y	Y	n/a	
Linux SLES 10 SP4	Y	Y	n/a	
Linux SLES 11 SP1	Y	Y	Ν	
DOS* NDIS 2	Y	n/a	n/a	
DOS ODI	Y	n/a	n/a	
UEFI* 2.1	Ν	Y	Ν	
UEFI* 2.3	N	Y	Ν	
VMware* ESX 4.0 ³	n/a	Y	n/a	
VMware ESX 4.1 ³	n/a	Y	n/a	
VMware ESX 5.0 ³	n/a	Y	n/a	
Xen ⁴	n/a	Y	n/a	

Key: Y=affected; N=not affected; n/a=OS not available on specified architecture, n/s=OS not supported by LADSW on specified architecture.

1. Itaniun™ Product Family

2. Minimal Validation

3. VMware ESX drivers are not included on LAD SW Release CDs. They are available only from VMware's web site and are released on a separate schedule.

4. SR-IOV validation only

1. Feature to be enabled in Post-Launch Release.

NOTE: Low Halogen applies only to halogenated flame retardants and PVC in components. Halogens are below 1,000ppm bromine and 1,000ppm chlorine.

By using this document, in addition to any agreements you have with Intel, you accept the terms set forth below.

You may not use or facilitate the use of this document in connection with any infringement or other legal analysis concerning Intel products described herein. You agree to grant Intel a non-exclusive, royalty-free license to any patent claim thereafter drafted which includes subject matter disclosed herein.

INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DIS-CLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EM-PLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published spe-

cifications. Current characterized errata are available on request.

Contact your local Intel sales office or your distributor to obtain the latest specifications and before placing your product order.

0914/LH. RE

Copies of documents which have an order number and are referenced in this document, or other Intel literature, may be obtained by calling 1-800-548-4725, or go to: http://www.intel.com/design/literature.htm.

Intel and Intel logo are trademarks or registered trademarks of Intel Corporation or its subsidiaries in the United States and other countries.

Copyright ©2014 Intel Corporation

*Other names and brands may be claimed as the property of others.

Product Codes	
Dual Port Copper	CODE
Intel® Ethernet Server Adapter I350-T2	I350T2V2
Bulk Pack—Order 5, Get 5–RJ45 IEEE	I350T2V2BLK
Quad Port Copper	CODE
Intel® Ethernet Server Adapter I350-T4V2	I350T4V2
Bulk Pack—Order 5, Get 5–RJ45 IEEE	I350T4V2BLK
Dual Port Fiber	CODE
Intel® Ethernet Server Adapter I350-F2	1350F2
Bulk Pack—Order 5, Get 5–LC Fiber Optic IEEE	I350F2BLK
Quad Port Fiber	CODE
Intel® Ethernet Server Adapter I350-F4	I350F4

For Product Information

Bulk Pack—Order 5, Get 5–LC Fiber Optic IEEE

To see the full line of Intel Network Adapters for PCI Express, visit www. intel.com/go/ethernet.

I350F4BLK

To speak to a customer service representative regarding Intel products, please call 1-800-538-3373 (U.S. and Canada) or visit support.intel.com/ support/go/network/contact.htm for the telephone number in your area.

Warranty

Limited lifetime hardware warranty within 90 days of purchase. See the support document for complete warranty information at www.intel.com/support/network/sb/cs-009721.htm.

Customer Support

Intel® Customer Support Services offers a broad selection of programs including phone support and warranty service. For more information, contact us at support.intel.com/support/go/network/ (Service and availability may vary by country.)

To see the full line of Intel Ethernet Controllers, visit: www.intel.com/go/ethernet. For more information, contact your Intel sales representative.

325511-006US

intel

Printed in USA

Recycle